



CP-FSR6

FILM GRADE SILICA-R6 POLYESTER CHIPS

PRODUCT FEATURES AND APPLICATION

CP-FSR6 film grade Silica polyester chips. It is suitable for manufacturing of polyester films for flexible packaging as well as industrial applications. This chips content 6,000 ppm of silica.

TEST PARAMETERS		UNIT	TEST METHOD	TYPICAL VALUE
Intrinsic Viscosity		dl/gm	CPQA/WI/30	0.64±0.02
End Group (COOH)		Meq/kg	CPQA/WI/32	<35
DEG		%	CPQA/WI/52	1.1±0.2
Melting Point		Deg C	CPQA/WI/36	256±2
Color	L*		CPQA/WI/37	>60
	b*		CPQA/WI/37	<10
Ash		%	CPQA/WI/38	0.60 ±/0.02
Moisture content (When packed)		%	CPQA/WI/41	<0.30
Chip/gm		Nos	CPQA/WI/50	30±5

FOOD CONTACT

CP-FSR10 complies with EC and FDA regulations.

STORAGE & HANDLING

Recommened to store at temperature below 30°C & humidity 55±5 %

DISCLAIMER

The property given in this technical data sheet do not constitute product specifications but represent typical performance values based on the best of our knowledge and believed to be accurate. These are given in good faith but it is for the customer to satisfy of the suitability for its own particular purpose. The user is solely responsible for the end use of the product and needs to perform their own tests to confirm the product suitability/compatibility in all respects. Chiripal Polyfilm does not guarantee the typical values and reserves the right to change the technical data sheet at any time for enhancing the quality of the products without prior information.

Manufactured by.:



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